

Notification# 20191003000
Datasheet for TLV9061, TLV9062, TLV9064
Information Only

Date: November 01, 2019

Dear TI Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

**Information Only
Attachments**

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TLV9062IDSGR	39080324
TLV9062IDSGR	99056JSK

Technical details of this Product Change follow on the next page(s).

PCN Number:	20191003000	PCN Date:	Nov. 01, 2019
Title:	Datasheet for TLV9061, TLV9062, TLV9064		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
☐ Assembly Site	☐ Design	☐ Wafer Bump Site	
☐ Assembly Process	☒ Data Sheet	☐ Wafer Bump Material	
☐ Assembly Materials	☐ Part number change	☐ Wafer Bump Process	
☐ Mechanical Specification	☐ Test Site	☐ Wafer Fab Site	
☐ Packing/Shipping/Labeling	☐ Test Process	☐ Wafer Fab Materials	
		☐ Wafer Fab Process	
Notification Details			
Description of Change:			
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.			
			
Changes from Revision I (May 2019) to Revision J			
- Deleted TLV9062IDDFR (SOT-23 (8)) package preview notations throughout data s - Added industry standard package names to <i>Device Comparison Table</i> - Added note to packages with thermal pads, specifying that the thermal pads need t - Added link to <i>Shutdown Function</i> section in SHDN pin function rows			
The datasheet number will be changing.			
Device Family	Change From:	Change To:	
TLV9061, TLV9062, TLV9064	SBOS839I	SBOS839J	
These changes may be reviewed at the datasheet links provided.			
http://www.ti.com/product/TLV9061			
Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
See page 2			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.